

# SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : **CL05F153ZA5NNNC**
- Description : **CAP, 15nF, 25V, -20/+80%, Y5V, 0402**

## A. Samsung Part Number

CL 05 F 153 Z A 5 N N N C  
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

<b>① Series</b>	Samsung Multi-layer Ceramic Capacitor		
<b>② Size</b>	0402 (inch code)	L: 1.0 ± 0.05 mm	W: 0.5 ± 0.05 mm
<b>③ Dielectric</b>	Y5V	<b>⑧ Inner electrode</b>	Ni
<b>④ Capacitance</b>	15 nF	<b>Termination</b>	Cu
<b>⑤ Capacitance tolerance</b>	-20/+80 %	<b>Plating</b>	Sn 100% (Pb Free)
<b>⑥ Rated Voltage</b>	25 V	<b>⑨ Product</b>	Normal
<b>⑦ Thickness</b>	0.5 ± 0.05 mm	<b>⑩ Special</b>	Reserved for future use
		<b>⑪ Packaging</b>	Cardboard Type, 7" reel

## B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
<b>Capacitance</b>	Within specified tolerance	1kHz±10%      1.0±0.2Vrms
<b>Tan δ (DF)</b>	0.05 max.	
<b>Insulation Resistance</b>	10,000Mohm or 500Mohm·μF Whichever is Smaller	Rated Voltage      60~120 sec.
<b>Appearance</b>	No abnormal exterior appearance	Microscope (×10)
<b>Withstanding Voltage</b>	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
<b>Temperature Characterisitcs</b>	Y5V (From -30℃ to 85℃, Capacitance change should be within -82~+22%)	
<b>Adhesive Strength of Termination</b>	No peeling shall be occur on the terminal electrode	500g·F, for 10±1 sec.
<b>Bending Strength</b>	Capacitance change : within ±30%	Bending to the limit (1mm) with 1.0mm/sec.
<b>Solderability</b>	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
<b>Resistance to Soldering heat</b>	Capacitance change : within ±20% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	<b>Performance</b>	<b>Test condition</b>
<b>Vibration Test</b>	Capacitance change : within $\pm 20\%$ Tan $\delta$ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours $\times$ 3 direction (x, y, z)
<b>Moisture Resistance</b>	Capacitance change : within $\pm 30\%$ Tan $\delta$ : 0.09 max IR : 500Mohm or 25Mohm $\cdot \mu F$ Whichever is Smaller	With rated voltage 40 $\pm$ 2 $^{\circ}$ C, 90~95%RH, 500+12/-0hrs
<b>High Temperature Resistance</b>	Capacitance change : within $\pm 30\%$ Tan $\delta$ : 0.09 max IR : 1000Mohm or 50Mohm $\cdot \mu F$ Whichever is Smaller	With 200% of the rated voltage Max. operating temperature  1000+48/-0hrs
<b>Temperature Cycling</b>	Capacitance change : within $\pm 20\%$ Tan $\delta$ , IR : initial spec.	1 cycle condition Min. operating temperature $\rightarrow$ 25 $^{\circ}$ C $\rightarrow$ Max. operating temperature $\rightarrow$ 25 $^{\circ}$ C  5 cycle test

**C. Recommended Soldering method :**

Reflow ( Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C, 10sec. Max )

\* For the more detail Specification, Please refer to the Samsung MLCC catalogue.